Notification Number:	20160824000			Notification Date:			08/25/2016	
Title: Datasheet for TLC082-Q1/TLC084-Q1								
Customer Contact: PCN A	Manager Dept: Quality Services							
Change Type:								
Assembly Site		Design			Wafer Bump Site			
Assembly Process				Wafer Bump Material				
Assembly Materials		Part number change				Wafer Bump Process		
Mechanical Specification		Test Site			Wafer Fab Site			
Packing/Shipping/Labeli	nipping/Labeling Test Process				4	Wafer Fab Materials		
Notification Details					Wafer Fab Process			
Notification Details								
Description of Change: Texas Instruments Incorporated is announcing an information only notification.								
The product datasheet(s) is								
The product datasheet(s) is	apaatea as	Seen in the th	unge i	101151011	1115	cory below.		
						=.		
						TE:	XAS STRUMENTS	
TLC082-Q1, TLC084-Q1						11/3	STRUMENTS	
							www.ti.com	
Changes from Revision C (January	2016) to Revi	sion D					Page	
	•						<u>-</u>	
Deleted the Maximum Power Dissipation vs Free-Air Temperature graph								
Added the Receiving Notification of Documentation Updates section								
The datasheet number will be changing.								
Device Family	Change Fron	From:			Change To:			
TLC082-Q1/TLC084-Q1		SLOS510E				.OS510D		
These changes may be reviewed at the datasheet links provided.								
http://www.ti.com/lit/ds/symlink/tlc084-q1.pdf								
	•							
Reason for Change:								
To more accurately reflect de	evice chara	cteristics.						
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):								
No anticipated impact. This is	s a specific	ation change a	nnoun	ncement	or	ily. There ar	e no changes	
to the actual device	fi antinu	soulting for	Albi a	i fi				
Changes to product identi	fication re	esulting from	this r	notifica	itio	n:		
Changes to product identi None.	fication r	esulting from	this r	notifica	itio	n:		
Changes to product identi	fication re	esulting from	this r	notifica	ntio	n:		

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com